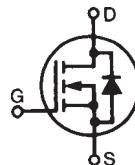


TrenchTTM Power MOSFET

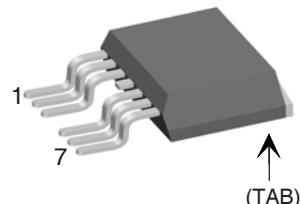
N-Channel Enhancement Mode
Avalanche Rated

IXTA230N075T2-7

V_{DSS} = 75V
 I_{D25} = 230A
 $R_{DS(on)}$ ≤ 4.2mΩ



TO-263 (7-lead)



| Symbol | Test Conditions | Maximum Ratings | |
|------------|---|-----------------|----|
| V_{DSS} | T_J = 25°C to 175°C | 75 | V |
| V_{DGR} | T_J = 25°C to 175°C, $R_{GS} = 1M\Omega$ | 75 | V |
| V_{GSM} | Transient | ± 20 | V |
| I_{D25} | T_c = 25°C | 230 | A |
| I_{LRMS} | Lead Current Limit, RMS | 160 | A |
| I_{DM} | T_c = 25°C, pulse width limited by T_{JM} | 700 | A |
| I_A | T_c = 25°C | 115 | A |
| E_{AS} | T_c = 25°C | 850 | mJ |
| P_D | T_c = 25°C | 480 | W |
| T_J | | -55 ... +175 | °C |
| T_{JM} | | 175 | °C |
| T_{stg} | | -55 ... +175 | °C |
| T_L | 1.6mm (0.062in.) from case for 10s | 300 | °C |
| T_{sold} | Plastic body for 10 seconds | 260 | °C |
| Weight | TO-263 | 3 | g |

Pins: 1 - Gate
2, 3 - Source
5,6,7 - Source
TAB (8) - Drain

Features

- International standard package
- 175°C Operating Temperature
- High current handling capability
- Avalanche rated
- Low $R_{DS(on)}$

Advantages

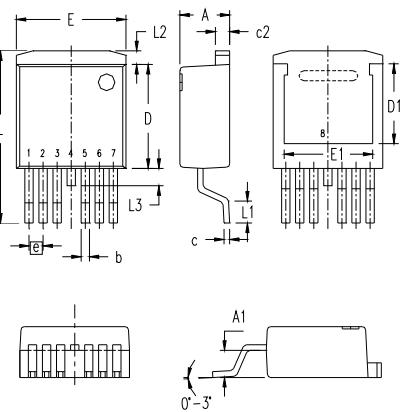
- Easy to mount
- Space savings
- High power density

Applications

- Automotive
 - Motor Drives
 - 12V Battery
 - ABS Systems
- DC/DC Converters and Off-line UPS
- Primary- Side Switch
- High Current Switching Applications

| Symbol | Test Conditions (T_J = 25°C unless otherwise specified) | Characteristic Values | | |
|--------------|---|-----------------------|---------|--------|
| | | Min. | Typ. | Max. |
| BV_{DSS} | $V_{GS} = 0V$, $I_D = 250\mu A$ | 75 | | V |
| $V_{GS(th)}$ | $V_{DS} = V_{GS}$, $I_D = 250\mu A$ | 2.0 | | V |
| I_{GSS} | $V_{GS} = \pm 20V$, $V_{DS} = 0V$ | | ±200 nA | |
| I_{DSS} | $V_{DS} = V_{DSS}$ $V_{GS} = 0V$ $T_J = 150^\circ C$ | | 5 μA | |
| $R_{DS(on)}$ | $V_{GS} = 10V$, $I_D = 50A$, Notes 1, 2 | | 150 μA | 4.2 mΩ |

| Symbol | Test Conditions ($T_J = 25^\circ\text{C}$, unless otherwise specified) | Characteristic Values | | |
|--------------|--|-----------------------|------|------|
| | | Min. | Typ. | Max. |
| g_{fs} | $V_{DS} = 10\text{V}$, $I_D = 60\text{A}$, Note 1 | 50 | 85 | S |
| C_{iss} | | | 10.5 | nF |
| C_{oss} | | | 1165 | pF |
| C_{rss} | | | 125 | pF |
| $t_{d(on)}$ | Resistive Switching Times $V_{GS} = 10\text{V}$, $V_{DS} = 0.5 \cdot V_{DSS}$, $I_D = 0.5 \cdot I_{D25}$ $R_G = 2\Omega$ (External) | | 23 | ns |
| t_r | | | 18 | ns |
| $t_{d(off)}$ | | | 33 | ns |
| t_f | | | 15 | ns |
| $Q_{g(on)}$ | | | 178 | nC |
| Q_{gs} | | | 53 | nC |
| Q_{gd} | | | 41 | nC |
| R_{thJC} | | | 0.31 | °C/W |

TO-263 (7-lead) (IXTA..7) Outline

Pins:
1 - Gate
2, 3 - Source
4 - Drain
5, 6, 7 - Source
Tab (8) - Drain

Source-Drain Diode

| Symbol | Test Conditions ($T_J = 25^\circ\text{C}$, unless otherwise specified) | Characteristic Values | | |
|----------|---|-----------------------|------|------|
| | | Min. | Typ. | Max. |
| I_s | $V_{GS} = 0\text{V}$ | | 230 | A |
| I_{SM} | Repetitive, Pulse width limited by T_{JM} | | 900 | A |
| V_{SD} | $I_F = 100\text{A}$, $V_{GS} = 0\text{V}$, Note 1 | | 1.3 | V |
| t_{rr} | $I_F = 115\text{A}$, $V_{GS} = 0\text{V}$ I_{RM} Q_{RM} | 66 | | ns |
| | | | 4.4 | A |
| | | | 145 | nC |

| SYM | INCHES | | MILLIMETER | |
|-----|--------|------|------------|-------|
| | MIN | MAX | MIN | MAX |
| A | .170 | .185 | 4.30 | 4.70 |
| A1 | .085 | .104 | 2.15 | 2.65 |
| b | .026 | .035 | 0.65 | 0.90 |
| c | .016 | .024 | 0.40 | 0.60 |
| c2 | .049 | .055 | 1.25 | 1.40 |
| D | .355 | .370 | 9.00 | 9.40 |
| D1 | .272 | .280 | 6.90 | 7.10 |
| E | .386 | .402 | 9.80 | 10.20 |
| E1 | .311 | .319 | 7.90 | 8.10 |
| e | .050 | BSC | 1.27BSC | |
| L | .591 | .614 | 15.00 | 15.60 |
| L1 | .091 | .110 | 2.30 | 2.80 |
| L2 | .039 | .059 | 1.00 | 1.50 |
| L3 | .000 | .059 | 0.00 | 1.50 |

Notes: 1. Pulse test, $t \leq 300\mu\text{s}$; duty cycle, $d \leq 2\%$.
2. On through-hole packages, $R_{DS(on)}$ Kelvin test contact location must be 5mm or less from the package body.

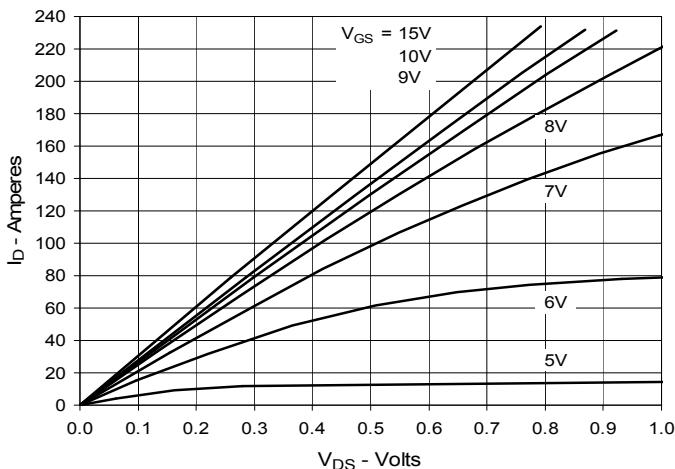
PRELIMINARY TECHNICAL INFORMATION

The product presented herein is under development. The Technical Specifications offered are derived from data gathered during objective characterizations of preliminary engineering lots; but also may yet contain some information supplied during a pre-production design evaluation. IXYS reserves the right to change limits, test conditions, and dimensions without notice.

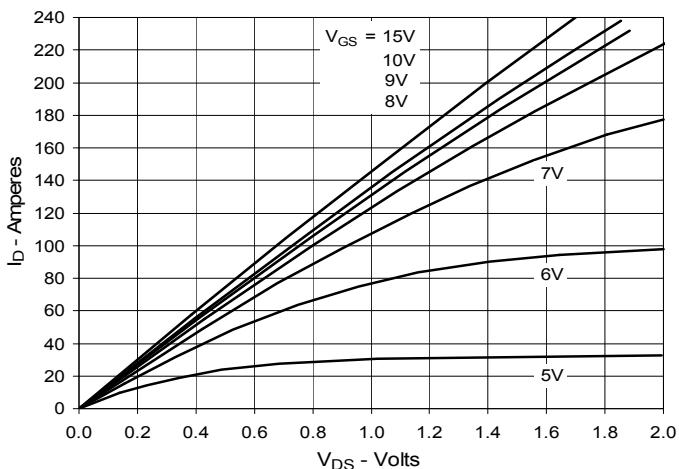
IXYS reserves the right to change limits, test conditions, and dimensions.

IXYS MOSFETs and IGBTs are covered by one or more of the following U.S. patents: 4,835,592 4,931,844 5,049,961 5,237,481 6,162,665 6,404,065 B1 6,683,344 6,727,585 7,005,734 B2 7,157,338B2 4,850,072 5,017,508 5,063,307 5,381,025 6,259,123 B1 6,534,343 6,710,405 B2 6,759,692 7,063,975 B2 4,881,106 5,034,796 5,187,117 5,486,715 6,306,728 B1 6,583,505 6,710,463 6,771,478 B2 7,071,537

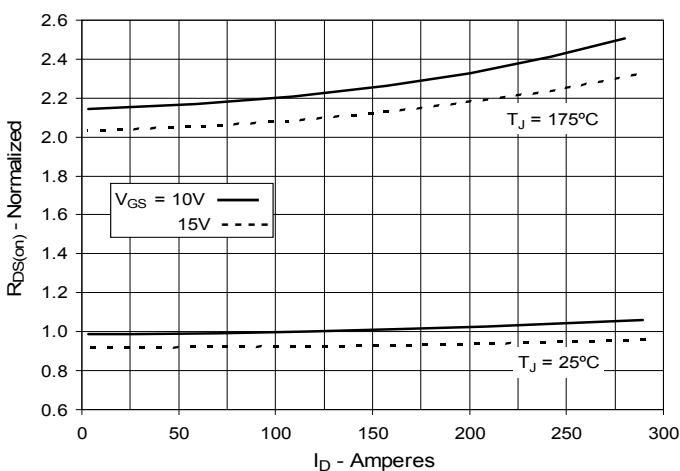
**Fig. 1. Output Characteristics
@ 25°C**



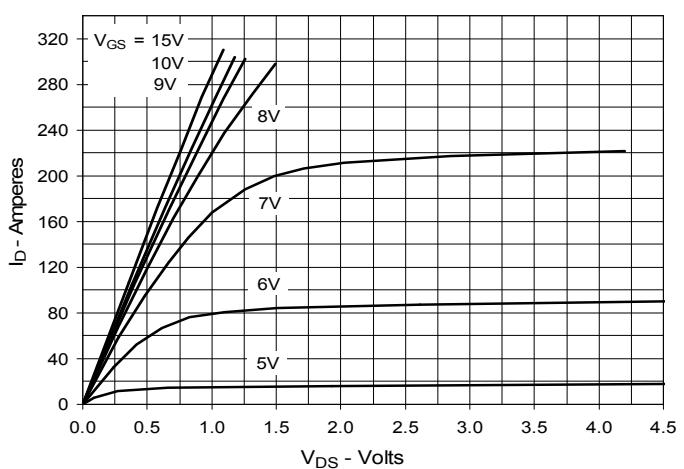
**Fig. 3. Output Characteristics
@ 150°C**



**Fig. 5. $R_{DS(on)}$ Normalized to $I_D = 115A$ Value
vs. Drain Current**



**Fig. 2. Extended Output Characteristics
@ 25°C**



**Fig. 4. $R_{DS(on)}$ Normalized to $I_D = 115A$ Value
vs. Junction Temperature**

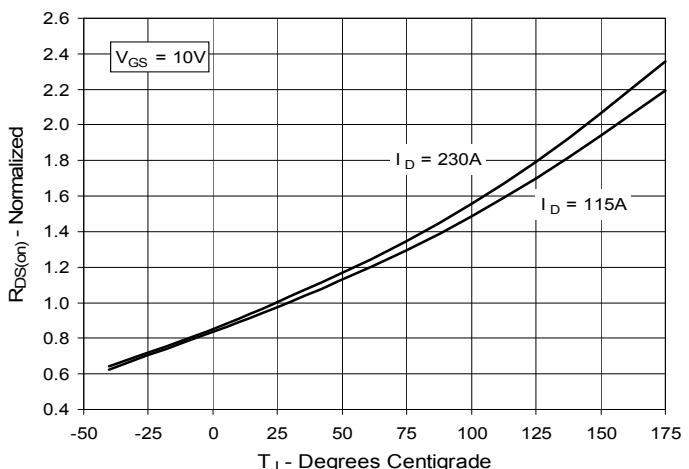


Fig. 6. Drain Current vs. Case Temperature

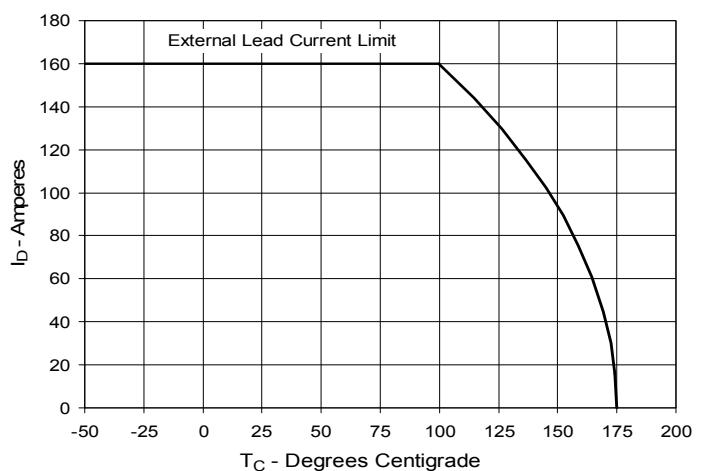
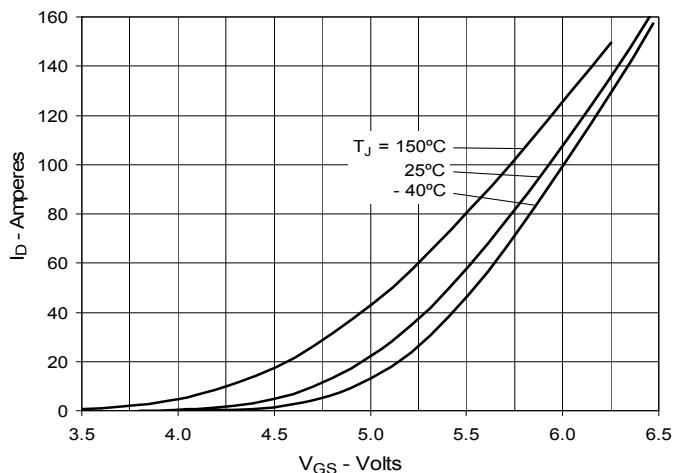
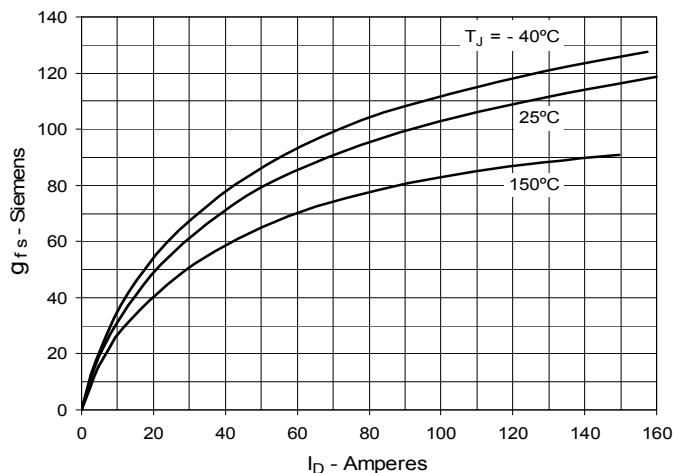
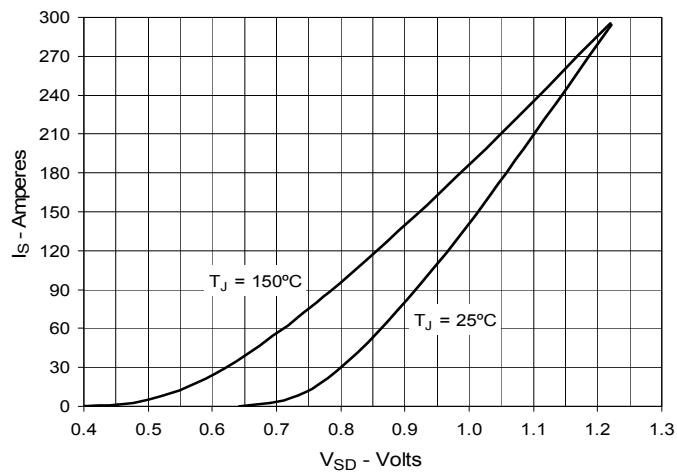
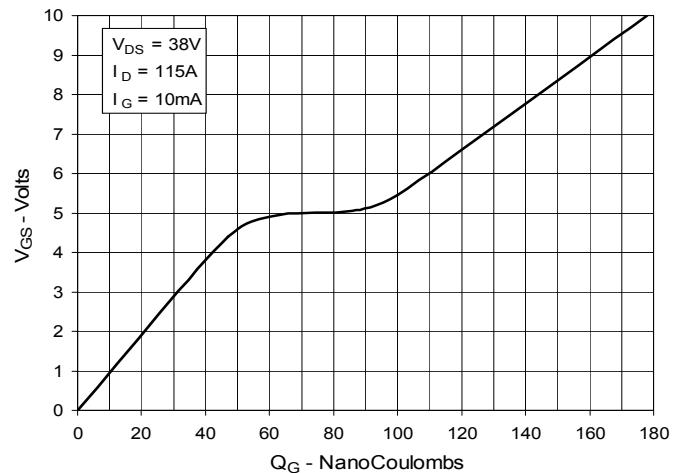
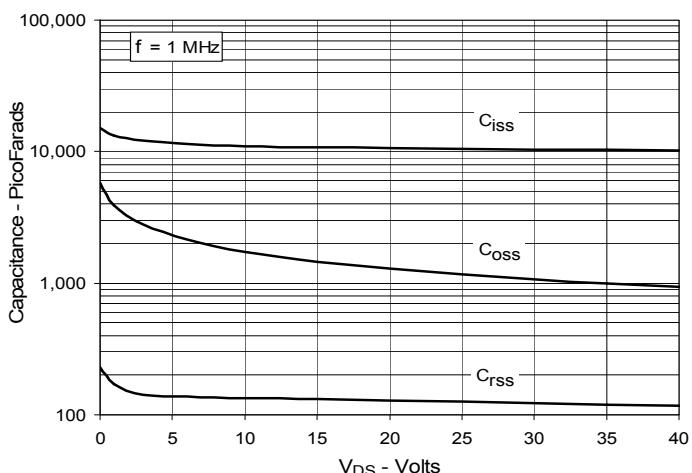
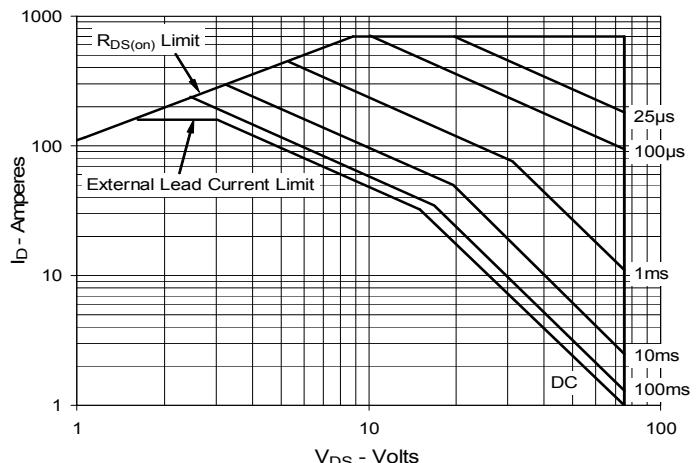
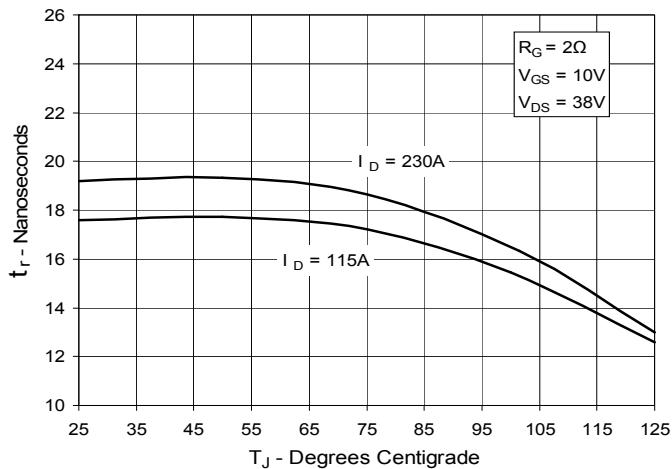


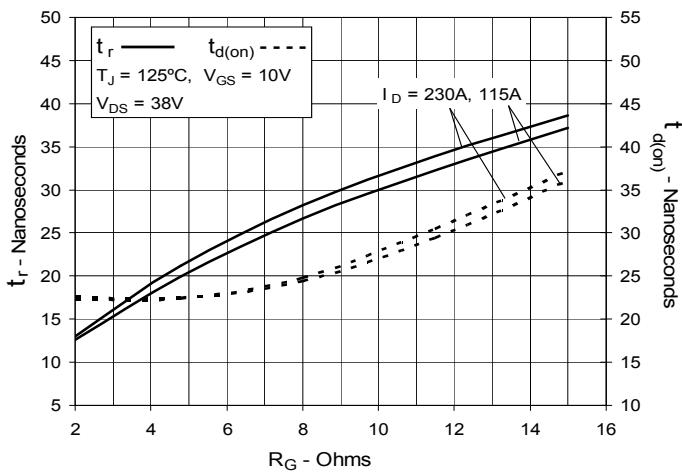
Fig. 7. Input Admittance**Fig. 8. Transconductance****Fig. 9. Forward Voltage Drop of Intrinsic Diode****Fig. 10. Gate Charge****Fig. 11. Capacitance****Fig. 12. Forward-Bias Safe Operating Area**

IXYS reserves the right to change limits, test conditions, and dimensions.

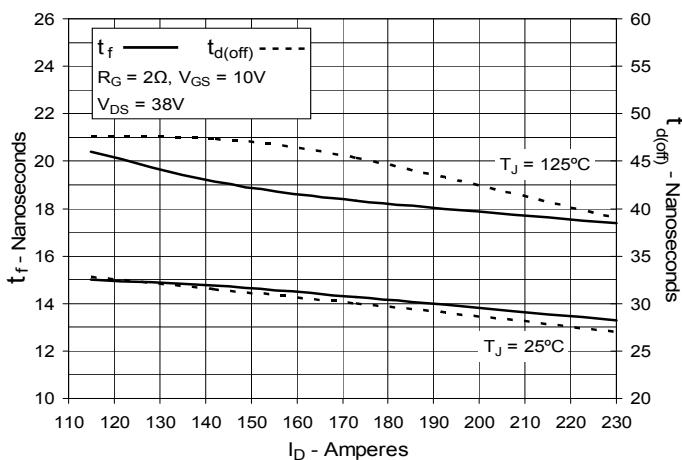
**Fig. 13. Resistive Turn-on
Rise Time vs. Junction Temperature**



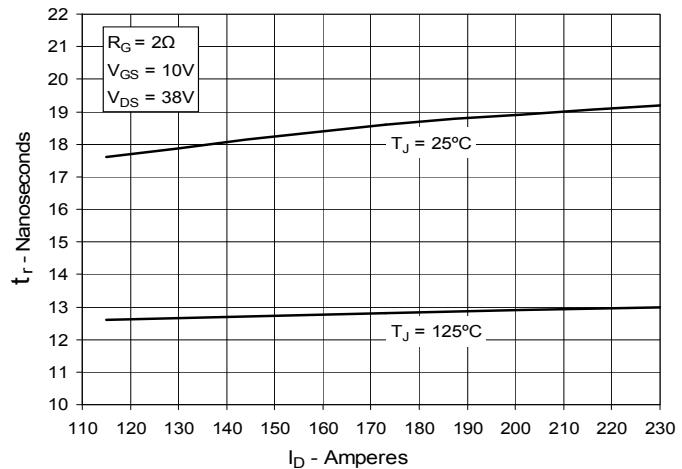
**Fig. 15. Resistive Turn-on
Switching Times vs. Gate Resistance**



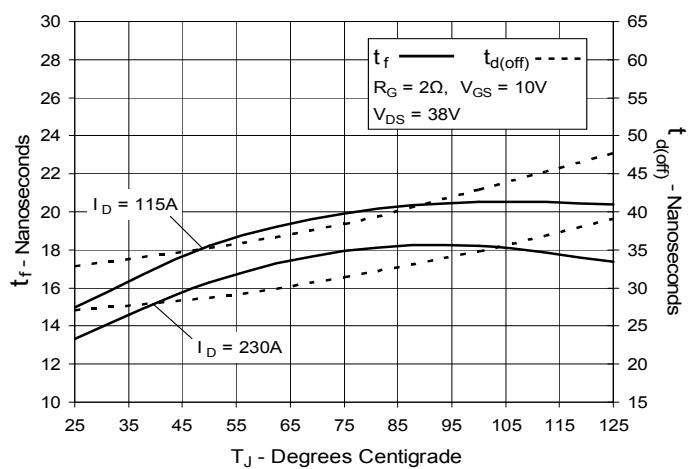
**Fig. 17. Resistive Turn-off
Switching Times vs. Drain Current**



**Fig. 14. Resistive Turn-on
Rise Time vs. Drain Current**



**Fig. 16. Resistive Turn-off
Switching Times vs. Junction Temperature**



**Fig. 18. Resistive Turn-off
Switching Times vs. Gate Resistance**

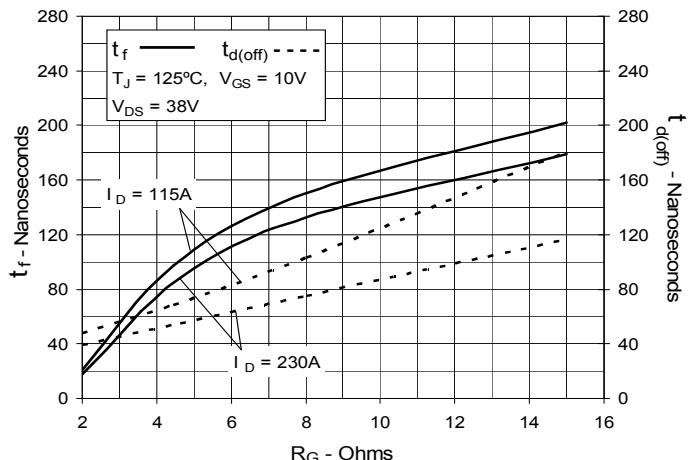
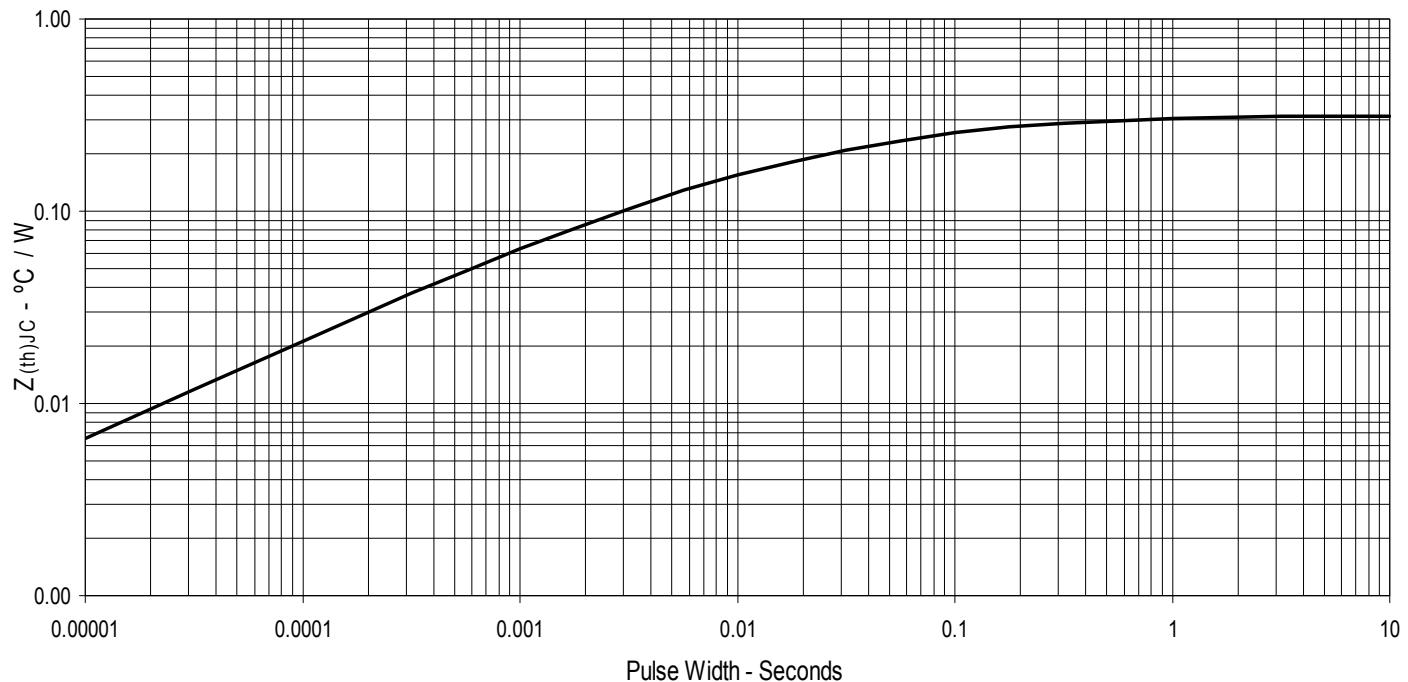


Fig. 19. Maximum Transient Thermal Impedance



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